

## IGBT

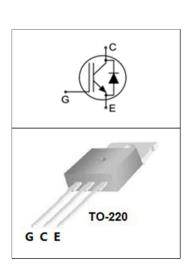
#### Features

- 650V,25A
- V<sub>CE(sat)(typ.)</sub>=2.1V@V<sub>GE</sub>=15V,I<sub>C</sub>=25A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

#### **General Description**

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as Motor control, general inverter and other soft switching applications.

#### Absolute Maximum Ratings



JNG25T65PS1

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	650	V
Vges	Gate-Emitter Voltage	<u>+</u> 30	V
	Continuous Collector Current ( Tc=25 $^\circ\!\mathrm{C}$ )	50	А
lc	Continuous Collector Current (Tc=100 $^\circ\!\!\!\mathrm{C}$ )	25	A
Ісм	Pulsed Collector Current (Note 1)	75	А
IF	Diode Continuous Forward Current ( $T_C {=} 100~^\circ {\rm C}$ )	25	A
lfм	Diode Maximum Forward Current (Note 1)	75	А
t <sub>sc</sub>	Short Circuit Withstand Time	10	us
D-	Maximum Power Dissipation ( $T_{C} \mbox{=} 25~\ensuremath{\mathbb{C}}\xspace$ )	139	W
PD	Maximum Power Dissipation ( $T_C=100^\circ\!\mathrm{C}$ )	56	W
TJ	Operating Junction Temperature Range	-55 to +150	°C
Tstg	Storage Temperature Range	-55 to +150	°C

### **Thermal Characteristics**

Symbol	Parameter	Max.	Units
Rth j-c	Thermal Resistance, Junction to case for IGBT	0.9	°C/W
R <sub>th j-c</sub>	Thermal Resistance, Junction to case for Diode	1.2	°C/W
R <sub>th j-a</sub>	Thermal Resistance, Junction to Ambient	62	°C/W



#### Electrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	650	-	-	V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V	-	-	100	uA
I <sub>GES</sub>	Gate Leakage Current, Forward	$V_{GE}$ =±20V, $V_{CE}$ = 0V	-	-	±100	nA
V <sub>GE(th)</sub>	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 250 \text{uA}$	5.1	-	6.9	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 25A	-	2.1	2.7	V
Qg	Total Gate Charge	_V <sub>cc</sub> =480V	-	31.2		nC
Qge	Gate-Emitter Charge	V <sub>GE</sub> =15V	-	7.7		nC
Qgc	Gate-Collector Charge	Ic=25A	-	13.3		nC
t d(on)	Turn-on Delay Time		-	22	-	ns
t r	Turn-on Rise Time	V <sub>CC</sub> =400V V <sub>GE</sub> =15V	-	44	-	ns
t d(off)	Turn-off Delay Time		-	75	-	ns
t f	Turn-off Fall Time	_I <sub>C</sub> =25Α _R <sub>G</sub> =15Ω	-	88	-	ns
Eon	Turn-on Switching Loss	Inductive Load	-	0.66	-	mJ
Eoff	Turn-off Switching Loss	T <sub>C</sub> =25 ℃	-	0.49	-	mJ
Ets	Total Switching Loss		-	1.15	-	mJ
Cies	Input Capacitance	V <sub>CE</sub> =25V	-	978	-	pF
Coes	Output Capacitance	V <sub>GE</sub> =0V	-	90	-	pF
Cres	Reverse Transfer Capacitance	f = 1MHz	-	8	-	pF

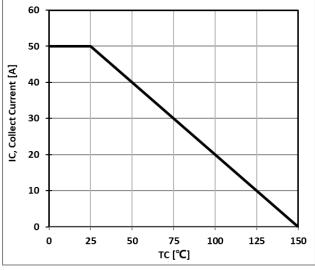
### Electrical Characteristics of Diode (Tc=25°C unless otherwise noted )

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> =25A	-	1.65	3.0	V
trr	Diode Reverse Recovery Time	V <sub>CE</sub> = 400V	-	60		ns
Irr	Diode peak Reverse Recovery Current	I <sub>F</sub> = 25A	-	15.6		А
Q <sub>r r</sub>	Diode Reverse Recovery Charge	Rg=15 Ω	-	518		nC

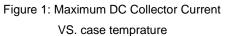
#### Notes:

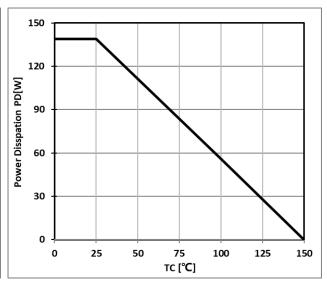
1. Repetitive Rating: Pulse width limited by maximum junction temperature



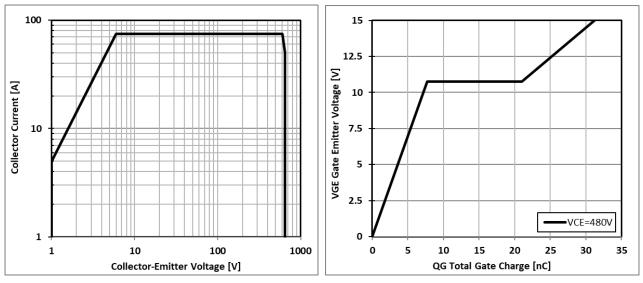


### **Typical Performance Characteristics**









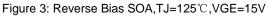
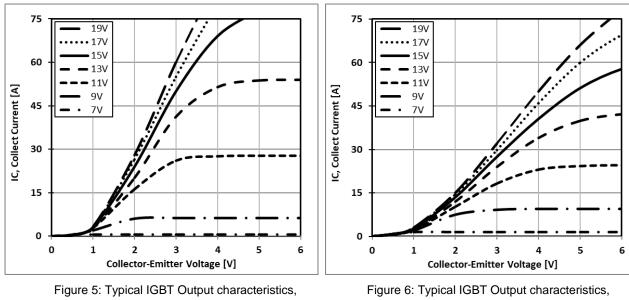


Figure 4: Typical Gate charge VS. VGE,IC=25A





TC=25°C;tp=300us

TC=150℃;tp=300us

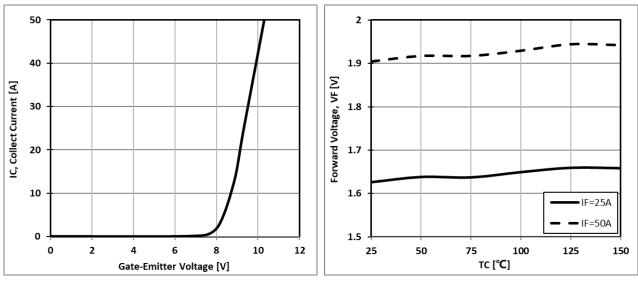
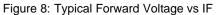
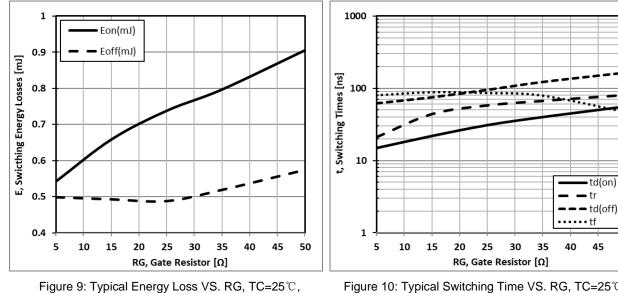


Figure 7: Typical Gate Threshold Voltage

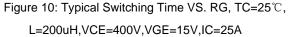


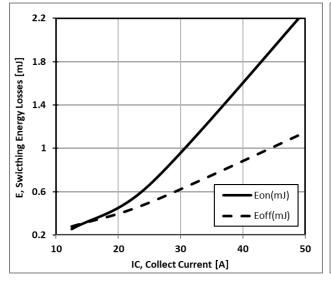


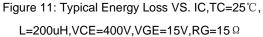
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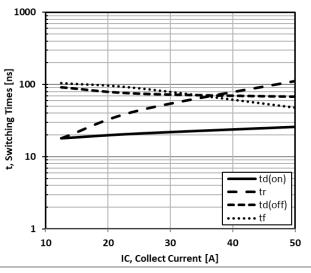


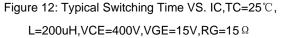
L=200uH,VCE=400V,VGE=15V,IC=25A



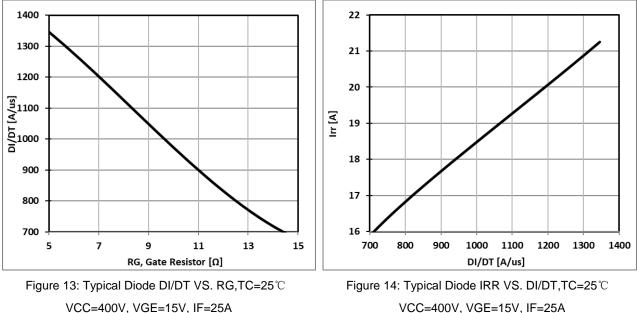




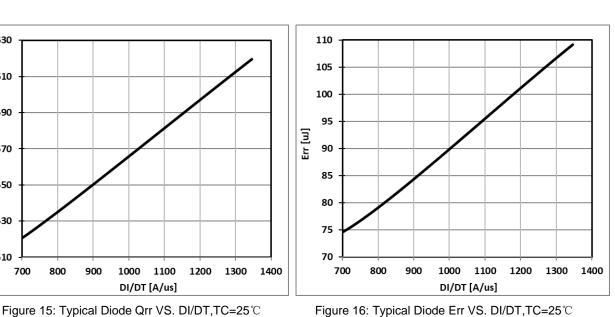








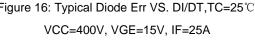






1000 1100

DI/DT [A/us]



800

900

630

610

590

570

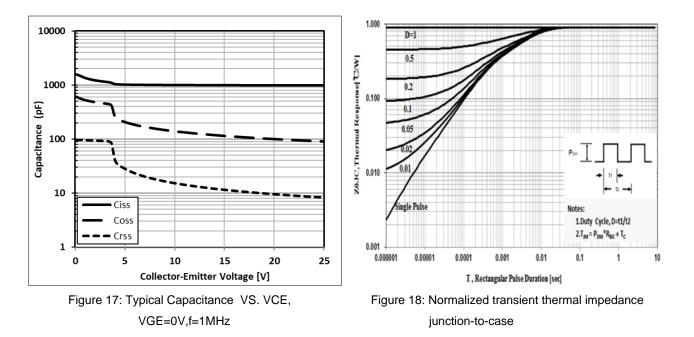
550

530

510 700

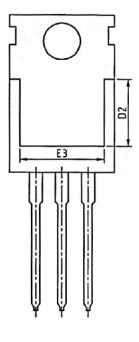
Qrr [nC]



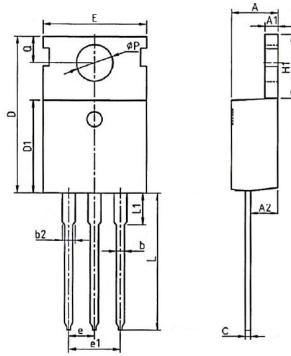




#### **TO-220C PACKAGE OUTLINE**



SYMBOL	MIN	NOM	MAX	
Α	4.37	4.57	4.7	
A1	1.25	1.3	1.4	
A2	2.2	2.4	2.6	
b	0.7	0.8	0.95	
b2	1.17	1.27	1.47	
С	0.45	0.5	0.6	
D	15.1	15.6	16.1	
D1	8.8	9.1	9.4	
D2	5.5	-	-	
E	9.7	10	10.3	
E3	7	-	-	
е	2.54 BSC			
e1	5.08 BSC			
H1	6.25	6.5	6.85	
L	12.75	13.5	13.8	
L1	-	3.1	3.4	
ΦР	3.4	3.6	3.8	
Q	2.6	2.8	3	





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